

Mini-Circuits

50Ω 0.05 to 1.5 GHz

#### THE BIG DEAL

- Dual matched amplifier for push-pull & balanced amplifiers
- High IP2 and IP3
- Gain, 16 dB typ. at 0.8 GHz
- P1dB, +22 dBm typ. at 0.8 GHz
- Low noise figure, 1.8 dB typ. at 0.8 GHz
- Two matched amplifiers in one package
- May be used as a replacement to WJ AH22<sup>a,b</sup>



Generic photo used for illustration purposes only

CASE STYLE: DL1020

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

#### **APPLICATIONS**

- CATV
- FTTH
- Optical networks
- Base station infrastructure
- Balanced amplifiers
- 75 Ohm push-pull and balanced amplifiers

#### **PRODUCT OVERVIEW**

Mini-Circuits PHA-22+ is a dual matched wideband amplifier fabricated using advanced E-PHEMT technology, offering high dynamic range (High IP3 and Low NF) for use in 50 and 75 ohm applications. Exceptionally high IP2 has been demonstrated in wideband 50 and 75 ohm amplifiers evaluation boards. Combining this with low noise figure to enable it for use in exceptionally high dynamic range amplifiers.

#### **KEY FEATURES**

Feature	Advantages
Broadband	Covers Cable TV band and communication bands such as Cellular, Cable TV, PCS, WiMAX etc.
Matched pair for use in exceptionally high IP2 amplifiers	Typical gain match of 0.2 dB and phase match of 1.6 deg. enables it to be used in push-pull amplifiers. Outstanding IP2.
High IP3, up to 43 dBm	Ideal for suppressing unwanted intermods in the presence of multi carriers, which is common in present day communi- cation systems.
Low Noise Figure: 1.8 dB typical	Compare this to the competitors, which is in the range of 4-6 dB. Mini-Circuits amplifier improves the dynamic range.
High P1dB: 22 dBm	High P1dB enables the amplifier to operate in linear region in the presence of strong interfering signals.

a. Suitability for model replacement within a particular system must be determined by and is solely the responsibility of the customer based on, among other things, electrical performance criteria, stimulus conditions, application, compatibility with other components and environmental conditions and stresses.

b. The WJ part number is used for identification and comparison purposes only.

REV. C ECO-010399 M151107 PHA-22+ MCL NY 211103

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#### ELECTRICAL SPECIFICATIONS<sup>1</sup> AT 25°C, Zo=50Ω AND DEVICE VOLTAGE 5V, UNLESS NOTED

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(Specifications (other than Matching or where defined as push-pull) are for each of the two matched amplifiers in the package)

Para	Condition (GHz)	Min.	Тур.	Max.	Units		
Frequency Range			0.05		1.5	GHz	
		0.05	_	17.7	_	dB	
Gain		0.8	14.5	16.1	17.7		
		1.5	_	15.4	_		
Input Return Loss		0.05		11.3			
		0.8		17.0		dB	
		1.5		11.7			
Output Return Loss		0.05		14.1		dB	
		0.8		18.8			
		1.5		13.1			
Output Power @1 dB compression <sup>(2)</sup>		0.05		22.4		dBm	
		0.8		22.5			
		1.5		22.5			
		0.05	_	41.4			
Output IP3 <sup>(6)</sup>		0.8	37.0	41.5		dBm	
		1.5	_	42.9			
		0.05		1.8			
Noise Figure		0.8		1.8		dB	
		1.5		2.0			
		0.05		0.11	_	dB	
	Amplitude Unbalance	0.8		0.12	0.6		
Matching between A1, A2		1.5		0.22	_		
		0.05		0.3	_		
	Phase Unbalance	0.8		1.0	5.0	deg.	
		1.5		1.6	_		
Device Operating Voltage			4.8	5.0	5.2	V	
Device Operating Current (each amplifier)			110	146	180	mA	
Device Current Variation vs. Temperature				23		µA/°C	
Device Current Variation vs Vo			0.053		mA/mV		
Thermal Resistance, junction-			34		°C/W		

#### **MAXIMUM RATINGS (4)**

Parameter	Ratings		
Operating Temperature <sup>(5)</sup>	-40°C to 85°C		
Storage Temperature	-55°C to 150°C		
Operating Current at 5V <sup>(6)</sup>	200 mA		
Power Dissipation <sup>(6)</sup>	1000 mW		
Input Power (CW)	+24 dBm		
DC Voltage (pads 5,8)	6V		

#### **PUSH-PULL AMPLIFIER TYPICAL PERFORMANCE (3)**

_	TB-566-75+ (75Ω)			TB-566-50+ (50Ω)			
Frequency (GHZ)	Gain (dB)	Output IP3 (dBm)	Output IP2 (dBm)	Gain (dB)	Output IP3 (dBm)	Output IP2 (dBm)	
0.05	14.2	45.0	79.0	15.2	45.0	82.0	
0.25	13.7	43.0	79.0	13.8	45.0	84.0	
0.45	14.0	42.0	81.0	13.8	44.0	81.0	
0.85	14.1	43.0	72.0	13.0	44.0	76.0	
1.20	13.8	40.6	78.0	12.0	43.0	72.0	
1.30	13.5	40.3	78.0				

(1) Measured on Mini-Circuits Test Board TB-561-22+ (characterization test circuit, Fig 1a.

(2) Current increases at P1dB

(3) Measured on evaluation boards (push-pull amplifiers) TB-566-50+ (50Ω) and TB-566-75+ (75Ω). See Characterization Test Circuit (Fig. 1b)

(4) Permanent damage may occur if any of these limits are exceeded. These ratings are not intended for continuous normal operation. (5)Defined with reference to ground pad temperature.

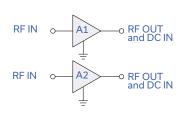
(6) Per single ended amplifier

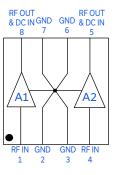
(7) Ojc= Junction Temperature-85°C / Voltage X sum of current in A1 & A2



#### SIMPLIFIED SCHEMATIC (EACH OF A1, A2) AND PIN DESCRIPTION

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Function	Pin Number	Description
RF IN, A1	1	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation. (see Application Circuit, Fig 2.)
RF-OUT and DC-IN, A1	8	RF output and bias pin. DC voltage is present on this pin; therefore a DC blocking capacitor is necessary for proper operation. An RF choke is needed to feed DC bias without loss of RF signal due to the bias connection, as shown in "Recommended Application Circuit", Fig 2
RF IN, A2	4	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation. (see Application Circuit, Fig 2.)
RF-OUT and DC-IN, A2	5	RF output and bias pin. DC voltage is present on this pin; therefore a DC blocking capacitor is necessary for proper operation. An RF choke is needed to feed DC bias without loss of RF signal due to the bias connection, as shown in "Recommended Application Circuit", Fig 2
GND	2,3,6,7 & paddle	Connections to ground. Use via holes as shown in "Suggested Layout for PCB Design" to reduce ground path inductance for best performance.

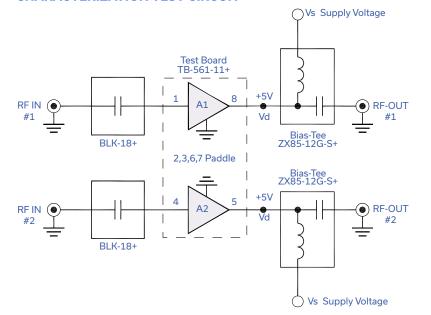
\* Enhancement mode pseudomorphic High Electron Mobility Transistor.

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**CHARACTERIZATION TEST CIRCUIT** 



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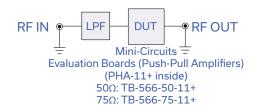


Fig 1b. Block Diagram of Test Set up used for characterization of Gain, IP2, IP3. Measured using Agilent's signal generators E8527D and Spectrum analyzer N9020A.

#### Conditions:

1. Two tones, spaced 1MHz apart, 5 dBm/tone at output. IP2 is measured at the sum frequency of the tones.

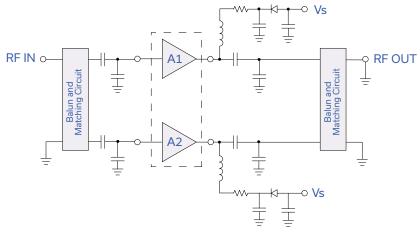
Fig 1a. Block Diagram of Test Circuit used for characterization. (DUT tested in Mini-Circuits Test board TB-561-22+, except for IP2) Gain, Return loss, Output power at 1dB compression (P1 dB), output IP3 (OIP3) and noise figure measured using Agilent's N5242A PNA-X microwave network analyzer.

#### Conditions:

1. Gain and Return loss: Pin= -25dBm

2. Output IP3 (OIP3): Two tones, spaced 1MHz apart, 5 dBm/tone at output.

#### **RECOMMENDED APPLICATION CIRCUIT**



#### **PRODUCT MARKING**



index over pin 1

Marking may contain other features or characters for internal lot control

Fig 2. Recommended Application Circuit. Refer to following Mini-Circuits Evaluation Boards for parts list.  $50\Omega$ : TB-566-50-11+  $75\Omega$ : TB-566-75-11+